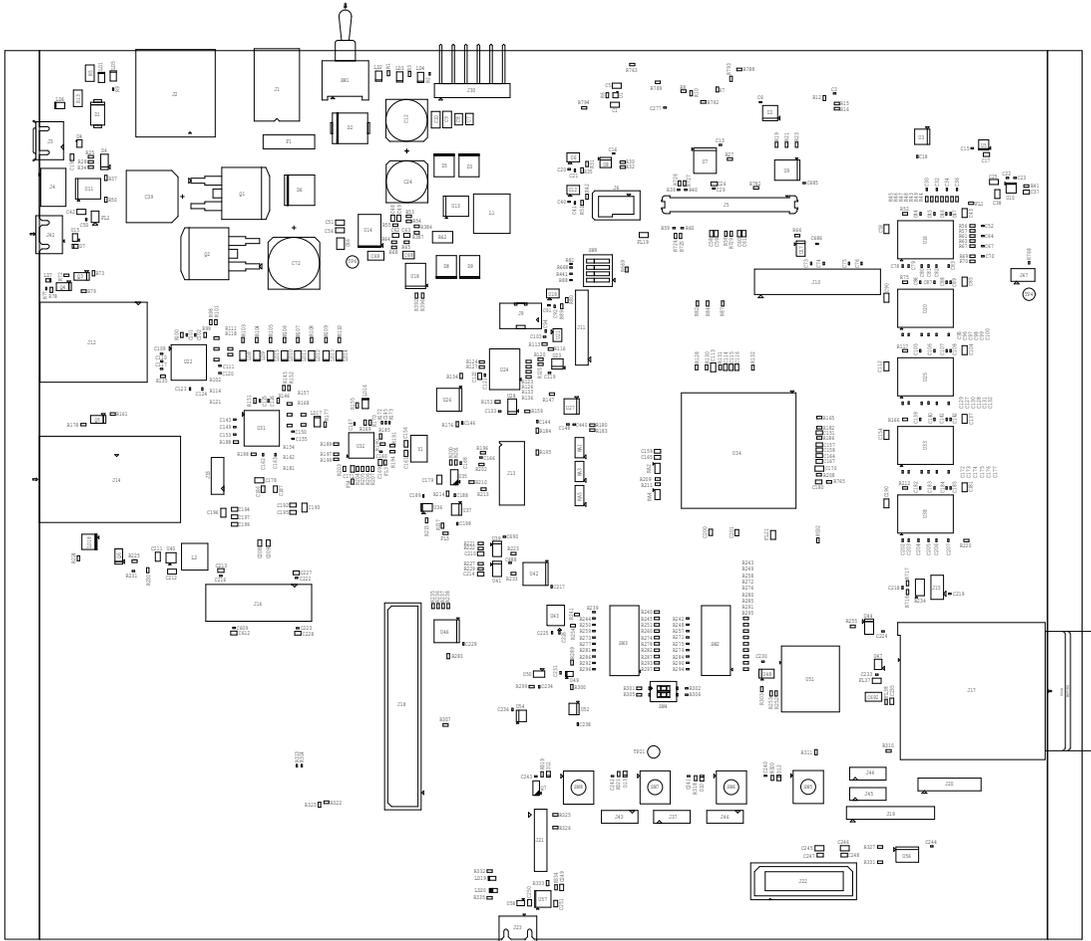


ASSEMBLY NOTES:-

- 1 - All MSL components should be baked as per JEDEC standard.
- 2 - PCB should be baked at 120 degree for 8 hours.
- 3 - Board assembly must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
- 4 - These assemblies are ESD sensitive, ESD precautions shall be observed.
- 5 - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- 6 - Provide serial numbers to the assembled boards for identification.
- 7 - The assembled board are wrapped in ESD Covers (individual) and packed securely before shipment.

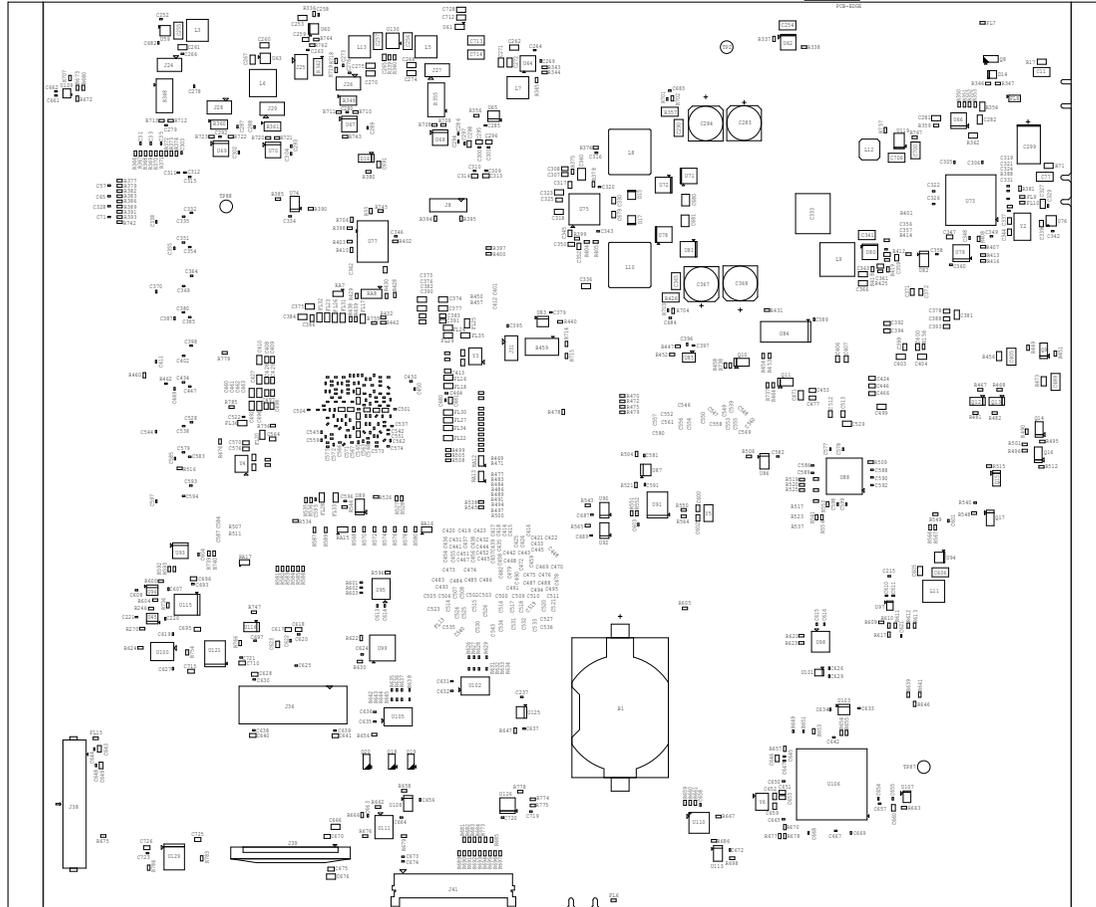


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|---|------------------|--------------|
|  TEXAS INSTRUMENTS | | PROC062 |
| BOARD NAME: AM654x EVM PROCESSOR BOARD | REV: E4 | DESCRIPTION: |
| SCALE: 1 | DATE: 28/08/2019 | SHEET OF 21 |

PROC062 E4 ASSEMBLY BOTTOM

ASSEMBLY NOTES:-

- 1 - All MSL components should be baked as per JEDEC standard.
- 2 - PCB should be baked at 120 degree for 8 hours.
- 3 - Board assembly must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
- 4 - These assemblies are ESD sensitive, ESD precautions shall be observed.
- 5 - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not accept
- 6 - Provide serial numbers to the assembled boards for identification.
- 7 - The assembled board are wrapped in ESD Covers(individual) and packed securely before shipment.



| | | |
|---|------------------|--------------|
|  TEXAS INSTRUMENTS | | PROC062 |
| BOARD NAME:AM654x EVM PROCESSOR BOARD | REV: E4 | DESCRIPTION: |
| SCALE: 1 | DATE: 28/08/2019 | SHEET OF 21 |